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June 2007

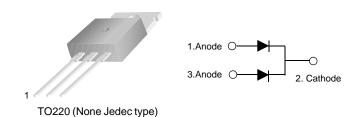
FYP1010DN

Schottky Barrier Rectifier

- · Low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

Applications

- Switched mode power supply
- Freewheeling diodes



Absolute Maximum Ratings *T_C=25°C unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------------------------|---|-------------|-------|
| V _{RRM} | Maximum Repetitive Reverse Voltage | 100 | V |
| V_{R} | Maximum DC Reverse Voltage | 100 | V |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 135°C | 10 | А |
| I _{FSM} | Non-repetitive Peak Surge Current (per diode) 60Hz Single Half-Sine Wave | 100 | А |
| T _{J,} T _{STG} | Operating Junction and Storage Temperature | -65 to +150 | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Units |
|-----------------|--|-------|-------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case (per diode) | 2.5 | °C/W |

Electrical Characteristics (per diode)

| Symbol | Parameter | | Value | Units |
|-------------------|---|---|------------------------------|-------|
| V _{FM} * | Maximum Instantaneous Forward Voltage $I_F = 5A$ $I_F = 5A$ $I_F = 10A$ $I_F = 10A$ | $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 125 ^{\circ}\text{C}$ $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 125 ^{\circ}\text{C}$ | 0.75 0.65 0.95 0.73 | V |
| I _{RM} * | Maximum Instantaneous Reverse Current @ rated V _R | $T_C = 25 ^{\circ}C$ $T_C = 125 ^{\circ}C$ | 1 30 | mA |

^{*} Pulse Test: Pulse Width=300μs, Duty Cycle=2%

Typical Performance Characteristics

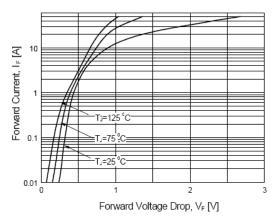


Figure 1. Typical Forward Voltage Characteristics (per diode)

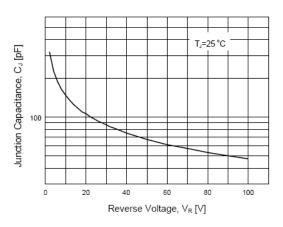


Figure 3. Typical Junction Capacitance (per diode)

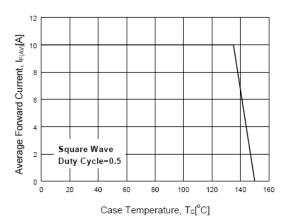


Figure 5. Forward Current Derating Curve

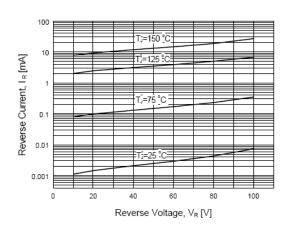


Figure 2. Typical Reverse Current vs. Reverse Voltage (per diode)

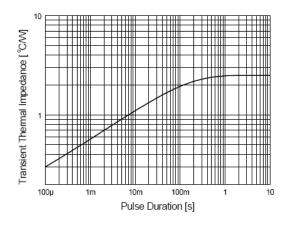


Figure 4. Thermal Impedance Characteristics (per diode)

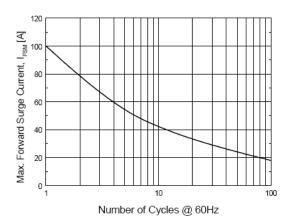
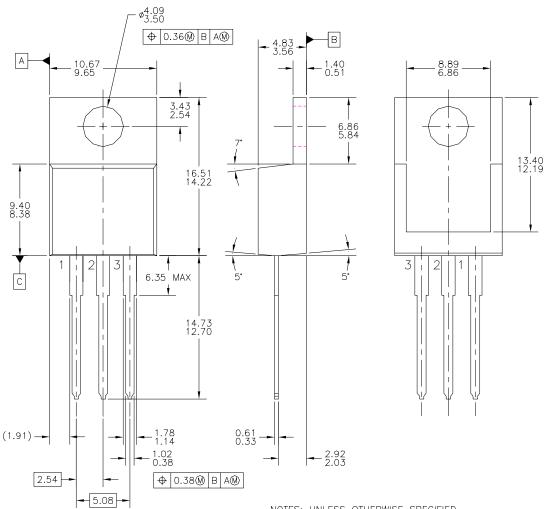
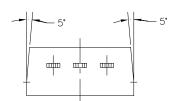


Figure 6. Non-Repetive Sureg Current (per diode)

Package Dimensions

TO-220





NOTES: UNLESS OTHERWISE SPECIFIED

- REFERENCE JEDEC, TO –220, ISSUE K, VARIATION AB, DATED APRIL, 2002. ALL DIMENSIONS ARE IN MILLIMETERS. DIMENSIONING AND TOLERANCING PER
- C) ANSI Y14.5 - 1973 LOCATION OF THE PIN HOLE MAY VARY
- (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE)

TO220B03REVD

Dimensions in Millimeters





UniFET™

VCX™

Wire™

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Programmable Active Droop™

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|--------------------------|------------------------|---|
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